D2





40V +175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 5)
40V	8.6mΩ @ V _{GS} = 10V	45A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, marking it ideal for high-efficiency power-management applications.

- Backlighting
- Power-management functions
- DC-DC converters

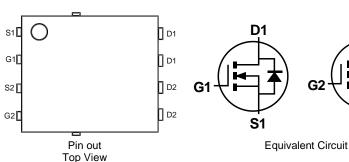
Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>DMTH4007SPDWQ</u>)

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





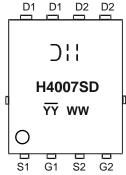
Ordering Information (Note 4)

Orderable Part Number	Package	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH4007SPDW-13	PowerDI5060-8/SWP (Type UXD)	2500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/
- 5. Package limited.

Marking Information



⊃¦¦ = Manufacturer's Marking
 H4007SD = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 24 = 2024)
 WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	40	V
Gate-Source Voltage			Vgss	±20	V
		T _C = +25°C (Note 5) T _C = +100°C	l _D	45 38.1	А
ICOntinuous Drain Current (Note /)		T _A = +25°C T _A = +100°C	ΙD	14.2 11.9	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	90	Α
Maximum Continuous Body Diode Forward Current (Note 6)			Is	34	Α
Avalanche Current, L = 0.1mH			las	20	Α
Avalanche Energy, L = 0.1mH			Eas	89	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	P _D	2.6	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{\theta JA}$	57	°C/W
Total Power Dissipation (Note 6)	PD	37.5	W	
Thermal Resistance, Junction to Case (Note 6)	Rejc	4	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C	

Notes:

- 5. Package limited.
- 7. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

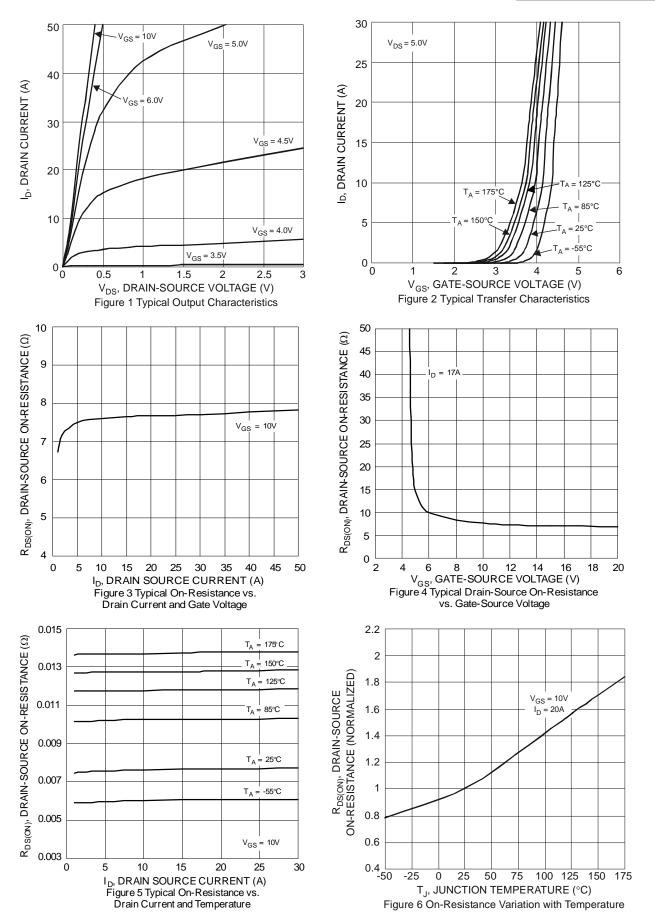
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage		_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	7.5	8.6	mΩ	Vgs = 10V, ID = 17A	
Diode Forward Voltage	VsD	_	0.85	_	V	V _G S = 0V, I _S = 17A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	2026	_	pF		
Output Capacitance	Coss		702	_	pF	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss		84.8	_	pF		
Gate Resistance	R _G		0.46	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	41.9	_	nC		
Gate-Source Charge	Qgs	_	10	_	nC	V _{DS} = 30V, I _D = 20A, V _{GS} = 10V	
Gate-Drain Charge	Qgd	_	11.5	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	7	_	ns		
Turn-On Rise Time	t _R	_	11.5	_	ns	V _{DD} = 30V, V _{GS} = 10V,	
Turn-Off Delay Time	tD(OFF)	_	15.6	_	ns	$I_D = 20A, R_G = 3\Omega$	
Turn-Off Fall Time	t _F	_	8.8	_	ns		
Body Diode Reverse-Recovery Time	t _{RR}		29.9	_	ns	L = 200 dl/dk = 4000//	
Body Diode Reverse-Recovery Charge	Qrr	_	23	_	nC	I _F = 20A, dI/dt = 100A/μs	

Notes:

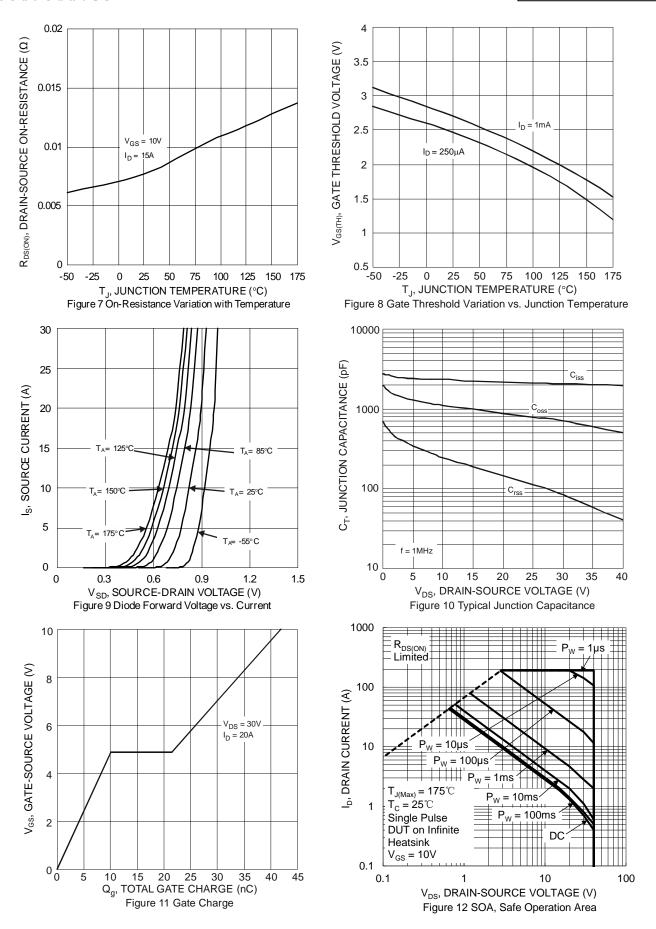
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.



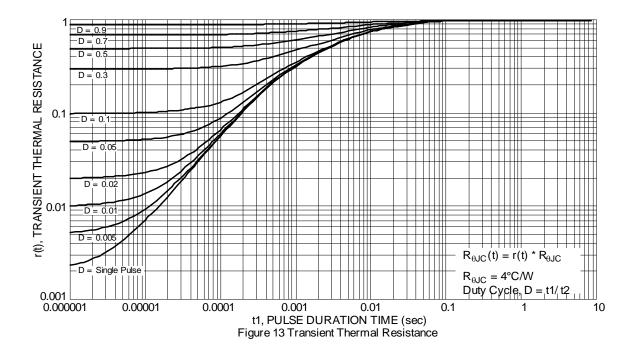










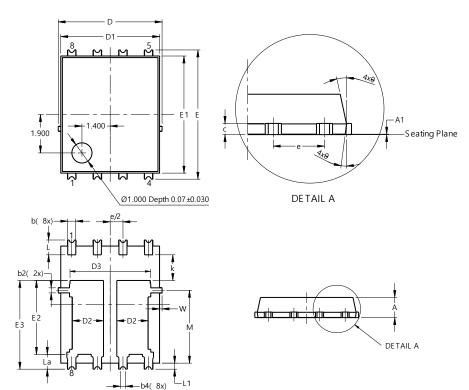




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)

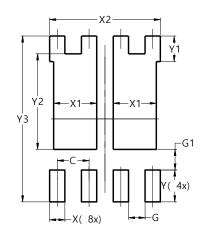


PowerDI5060-8/SWP (Type UXD)					
Dim	Min Max		Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	0.25REF				
С	0.230	0.330	0.277		
D	5	.15 BS0)		
D1	4.70	5.10	4.90		
D2	1.46	1.66	1.55		
D3	3.78	4.18	3.98		
Е	6	.40 BS0)		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
М	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	1.720		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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